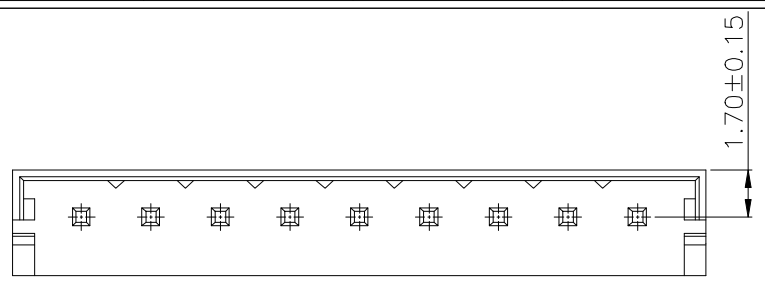
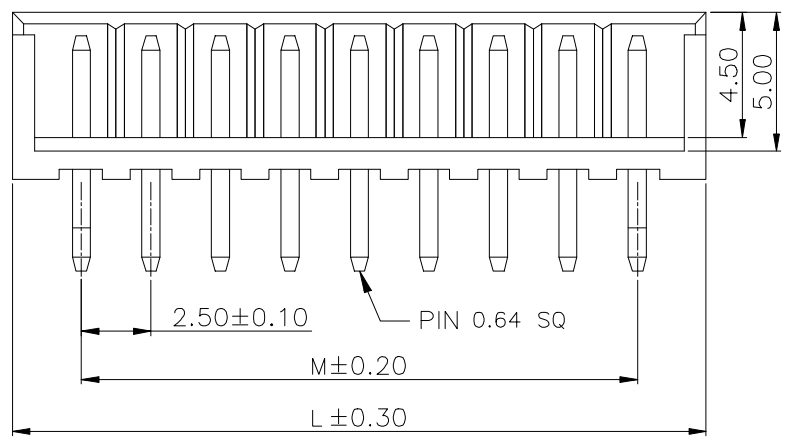


1 2 3 4 5 6 7 8 9

F



E



D

C

### Ordering Information

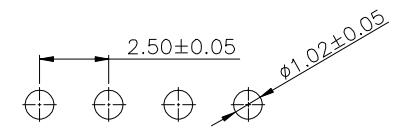
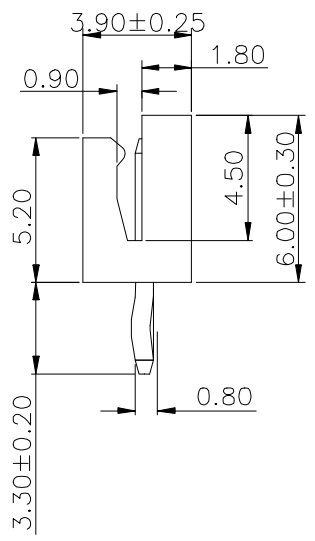
GWGA103 - XX XX A 801 E X B X

No. of Pins per Row 02~15

Standard Plating 01=Tin  
Selective Plating 02=Gold Flash

Color 2=White

Standard Packing N=PE Bag  
Selective Packing A=Box



Recommended P.C.Board Hole Layout

### Specifications

Current Rating: 2.5Amp (AC/DC)  
Voltage Rating: 250V (AC/DC)  
Insulation Resistance: 1000Ω Min.  
Dielectric Withstanding: 800V AC/Minute  
Contact Resistance: 10mΩ Max.  
Operating Temperature: -25°C to +85°C

### Materials

Contact Material: Brass  
Contact Plating: Tin Plated  
Insulation Material: Thermoplastic, UL 94V-0 Nylon 66 or the Equivalent material  
All materials must meet Greenconn requirement for environment protection.

No. of PIN/ROW	Dimension Information	
	M	L
02	2.50	7.50
03	5.00	10.00
04	7.50	12.50
05	10.00	15.00
06	12.50	17.50
07	15.00	20.00
08	17.50	22.50
09	20.00	25.00
10	22.50	27.50
11	25.00	30.00
12	27.50	32.50
13	30.00	35.00
14	32.50	37.50
15	35.00	40.00

A

**格稜股份有限公司**  
**Greenconn Corporation**

GENERAL TOLERANCE	
X. ±5.0°	X. ±0.30
.X' ±3.0°	.X ±0.25
.XX' ±2.0°	.XX ±0.15
.XXX' ±1.0°	.XXX ±0.10

DESIGN:	DATE:
CHECKED:	DATE:
AUDITED:	DATE:

DWG. NO. GWGA103-CA801EB
PART NO. GWGA103-XXXXA801EXBX

TITLE. 2.50 Wafer Straight
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REV. 02	UNIT. mm	SCALE. 1:1	PAGE. 1/1	
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1 2 3 4 5 6 7 8 9

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